

## Article

# A Pilot Study on Machining Difficult-to-Cut Materials with the Use of Tools Fabricated by SLS Technology

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**Abstract:** The growing use of contemporary materials in various industrial sectors, such as aerospace, automotive, as well as the oil and gas industry, requires appropriate machining methods and tools. Currently, apart from the necessity to obtain high-dimensional and shape accuracy, the efficiency and economic aspects of the selected manufacturing process are equally important, especially when difficult-to-cut materials, such as hard and brittle ceramics, have to be machined. In the research presented in this paper, a prototype tool fabricated from polyamide powder by the SLS method was used in flat-lapping of  $\text{Al}_2\text{O}_3$  ceramics, showing the promising potential and efficacy of rapid tooling and manufacturing in the area of abrasive machining. The influence of the selected input process factors, such as machining time, the type of abrasive suspension, kinematic parameters, and unit pressure, on technological effects, was analyzed. The microscopic observations of the active surface of the prototype tool showed its reinforcement with loose diamond abrasive particles (size D107), resulting in the effective material removal and improved surface finish of  $\text{Al}_2\text{O}_3$  ceramic samples. The directions for further development of tools fabricated by the SLS method for applications in abrasive machining were also envisaged by the authors.

**Keywords:** difficult-to-cut materials; finishing processes; rapid tooling; additive manufacturing; diamond grains; abrasive machining



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## 1. Introduction

Processing difficult-to-cut materials, such as superalloys, composites, titanium alloys, or advanced ceramics, contributes to the continuous development of finishing methods and abrasive tools. Conventional abrasive processes, such as grinding, lapping, polishing, and superfinishing, are still commonly used for finishing mechanical parts. Simultaneously, the production of components with increasingly complex geometries, e.g., by additive technologies, and the growing requirements from the industrial sectors make it necessary to develop new processes and tools, such as grinding with lapping kinematics using wheels with diamond or cubic boron nitride grains [1–4]. A study of the use of electroplated diamond wheels in lap-grinding, which allowed for effective machining of ceramic materials, was performed in [5–8]. Other examples of modern finishing processes based on abrasion are chemical mechanical polishing (CMP) [9], electrochemical polishing (ECP) [10], or ultrasonic cavitation abrasive finishing (UCAF) [11].

Ceramics, due to their superior properties such as good strength properties, low density, high hardness, as well as high temperature and chemical resistance, are widely used in many industrial areas and modern technological processes [12]. Ceramic cutting tools can be used for high-speed milling of heat-resistant superalloy IN718 [13]. Technical oxide ceramics  $\text{Al}_2\text{O}_3$  is commonly used for making, among others, electronic and electrical components [14,15]. On the other hand, hard and brittle ceramics are very difficult to machine. Machining ceramic materials is still a big challenge for the industry [16]. Deja et al. pointed out [17] that fabricating abrasive tools by additive manufacturing (AM) processes

is one of the promising directions in the development of novel finishing processes. This is due to the fact that AM technologies offer new opportunities in the fabrication of parts with strictly defined inner and outer geometries [18–20]. Moreover, even for abrasive tools with relatively simple geometric shapes, as in the case of lapping plates, AM technologies are cost-effective solutions for unit and small batch production, dedicated mainly for the fabrication of prototype tools. Less equipment is needed for production and postprocessing compared to subtractive technologies [16]. Powder bed fusion 3D-printing technologies based on metal alloys are widely used in the production of grinding wheels with a porous structure [21–24]. AM-based methods using curable resins can be used in the fabrication of lapping or polishing plates. Resin lapping wheels containing diamond abrasive grains enabled performing effective machining of hard and brittle ceramic materials [25,26]. Tools fabricated by selective laser sintering (SLS) can find application in grinding [27] or in lapping.

The SLS method used to produce lapping tools has rarely been studied, as indicated by Deja and Zieliński [17]. Herein, a prototype lapping plate was prepared by the SLS method and applied in the flat-lapping of technical ceramics  $Al_2O_3$ . The fabricated tool enabled the efficient material removal from hard and brittle ceramic samples. In the experimental tests, the influence of particular input process factors on the linear material loss and on the selected parameters of the geometrical structure of the machined surfaces was analyzed. As a result of the performed analysis, a determined set of machining parameters allowed obtaining technological effects characterized by good surface finish and relatively high material removal.

## 2. Materials and Methods

The prototype abrasive tool was made of polyamide PA 2200 powder by the selective laser sintering (SLS) method using an industrial EOS Formiga P100 3D printer (EOS GmbH, Krailling, Germany) according to the process chain given in Figure 1 and the set of process parameters presented in Table 1. Due to the limited space of the 3D printer's working chamber, the tool was divided into identical segments, which were then screwed to the metal body. The prototype lapping plate was composed of eight abrasive segments forming the uniform flat active surface of the tool (Figure 2). The cost of the fabrication of the prototype tool was approximately USD 200.

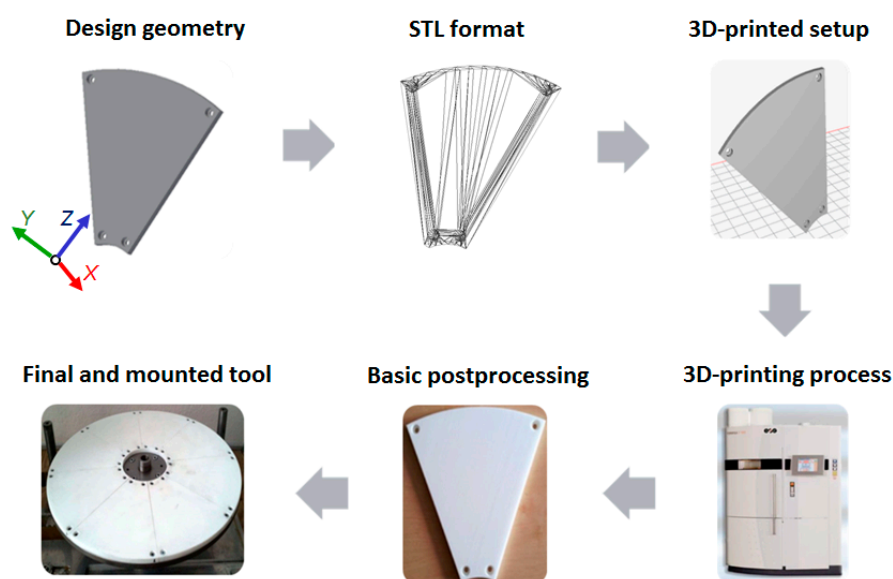
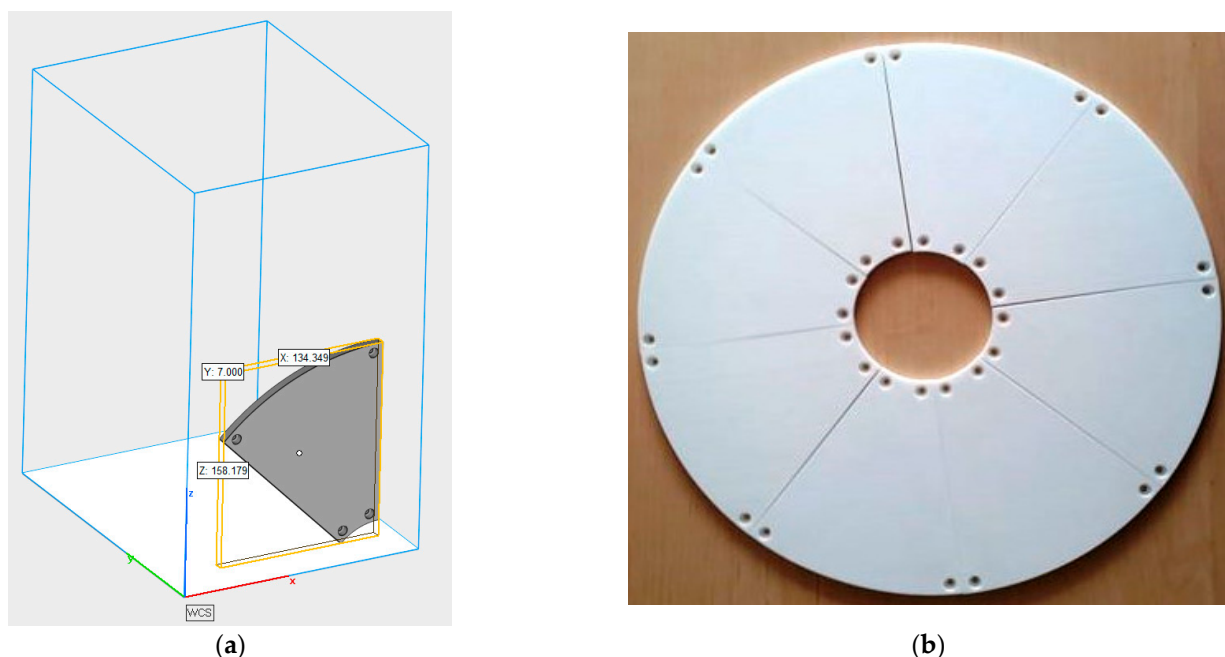


Figure 1. The 3D printing process chain of the SLS-lapping plate.

**Table 1.** Specification of the lapping tool and the parameters of the SLS process.

<b>Lapping Plate</b>	
Outer tool diameter	$d_o = 380$ mm
Inner tool diameter	$d_i = 90$ mm
Raw material	polyamide powder PA 2200
<b>SLS Process Parameter</b>	
Thickness of a single layer	100 $\mu$ m
Laser type	CO <sub>2</sub>
Power of laser	30 W
Length of laser beam	10.6 $\mu$ m
Printing speed	10 mm/s
Printing resolution	0.005 mm
<b>Postprocessing</b>	
Sandblasting and cleaning of unsintered powder particles using compressed air	



**Figure 2.** SLS-printed tool: (a) view of the printing position and dimensions of a single abrasive segment; (b) a prototype lapping plate consisting of eight abrasive segments.

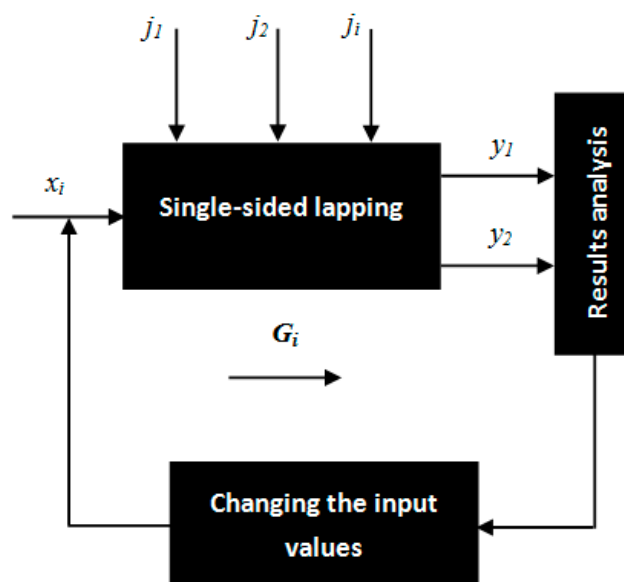
Experimental tests of the lapping samples from Al<sub>2</sub>O<sub>3</sub> were carried out on a machine tool (Gdańsk University of Technology, Gdańsk, Poland) equipped with two independent and programmable drive units of the lapping plate and leading ring [6]. The machine configuration allowed for the analysis of various kinematic parameters of the lapping process, which were changed using programmable indexers of stepper motors. Three identical cylindrical samples made of technical ceramics Al<sub>2</sub>O<sub>3</sub> (HV10 = 1100 MPa) with an outer diameter  $d_w = 34$  mm and an initial height  $h_{w0} = 30$  mm were used in the experimental tests. The diamond paste with grain size SD 28/20 and volumetric grain concentration in abrasive paste 20%, as well as loose diamond grains D107 with machining oil were used as the abrasive suspension ( $a_s$ ). After a single test, the height of the samples was measured using a Mitutoyo micrometer (Mitutoyo, Kawasaki, Japan) with a resolution of 0.001  $\mu$ m. Additionally, the surface roughness and waviness measurements were conducted using

a contact profiler HOMMEL TESTER T500 according to the DIN4777 standards. A total of nine measurements of each type were made on each sample. In addition, the Sneox 3D optical profiler (Sensofar, Barcelona, Spain) was used to perform three-dimensional measurements of the surface topography of the  $\text{Al}_2\text{O}_3$  samples.

### 3. Experimental Results

#### 3.1. Scheme of Experimental Tests and Process Factors

The influence of the abrasive suspension  $a_s$ , kinematic parameters related to the rotational speed of a lapping plate  $n_t$  and a leading ring  $n_w$ , machining time  $t$ , as well as unit pressure  $p$  on the technological effects were investigated during the experiments. The main purpose of this pilot study was to check the potential of the abrasive ability of the prototype tool demonstrated for the first time in the literature. Figure 3 shows the scheme of the experimental tests, taking into account the influence of particular input variables, constant values, and disturbing quantities on the output variables during single-sided lapping of  $\text{Al}_2\text{O}_3$  ceramic samples.



**Figure 3.** Scheme of the research tests of single-sided lapping with the prototype tool made by the SLS method. Characteristics of factors: X—dependent variables:  $x_1$ —type of abrasive suspension  $a_s$ : diamond paste with SD 28/20 diamond grains; D107 diamond grains with oil;  $x_2$ —unit pressure  $p$ : 6 kPa; 12 kPa;  $x_3$ —lapping time  $t$ : 60 s, 120 s, 240 s, 300 s, 480 s, 720 s; 940 s;  $x_4$ —rotational speed of the tool  $n_t$ : 60 rev/min, 120 rev/min;  $x_5$ —rotational speed of the leading ring (separator with workpieces)  $n_w$ : 31 rev/min; 60 rev/min. Y—dependent variables:  $y_1$ —linear material removal  $\Delta h$ ;  $y_2$ —surface roughness and waviness: Ra, Wa. G—constant factors during all tests:  $g_5$ —the machine tool for flat-lapping processes;  $g_6$ —direction of the rotation of the lapping plate and leading ring;  $g_7$ —the prototype SLS-printed lapping plate consisting of independent abrasive segments and made of polyamide powder with constant 3D printing process parameters;  $g_8$ —machining method: single-sided lapping of flat surfaces;  $g_9$ —material and geometry of the machined samples: cylindrical samples made of  $\text{Al}_2\text{O}_3$ ;  $g_{10}$ —methods of measuring the output variables. J—disturbing factors:  $j_1$ —inaccuracies in setting the kinematic parameters of lapping, quantity, and the method of spreading the abrasive paste on the surface of the lapping plate,  $j_2$ —the variation of the physical-mechanical properties of the lapping plate and the machined workpieces.

#### 3.2. Experimental Tests of Single-Sided Lapping of $\text{Al}_2\text{O}_3$ Ceramics

The set of process conditions and independent variables adopted during the experimental tests are given in Table 2. As this was the first usage of the tool fabricated by SLS technology in lapping, the values of particular process parameters given in Table 2

were selected for subsequent tests depending on the technological results obtained in the preceding tests.

**Table 2.** A set of machining parameters for pilot tests of single-sided lapping of technical ceramics  $\text{Al}_2\text{O}_3$ .

Test Number	X—Independent Variables				
	Unit Pressure $p$ (kPa)	Rotational Speed (rev/min)		Type of Abrasive Suspension (mL)	Lapping Time $\Delta t$ (s)
		Lapping Tool $n_t$	Leading Ring $n_w$		
T1	6	60	31	4 mL diamond paste SD 28/20	60; 120
T2	12	60	31	0.5 mL of abrasive grains D107	60; 240; 300; 480
T3	12	120	60	0.5 mL of abrasive grains D107	120; 240; 480; 720; 940

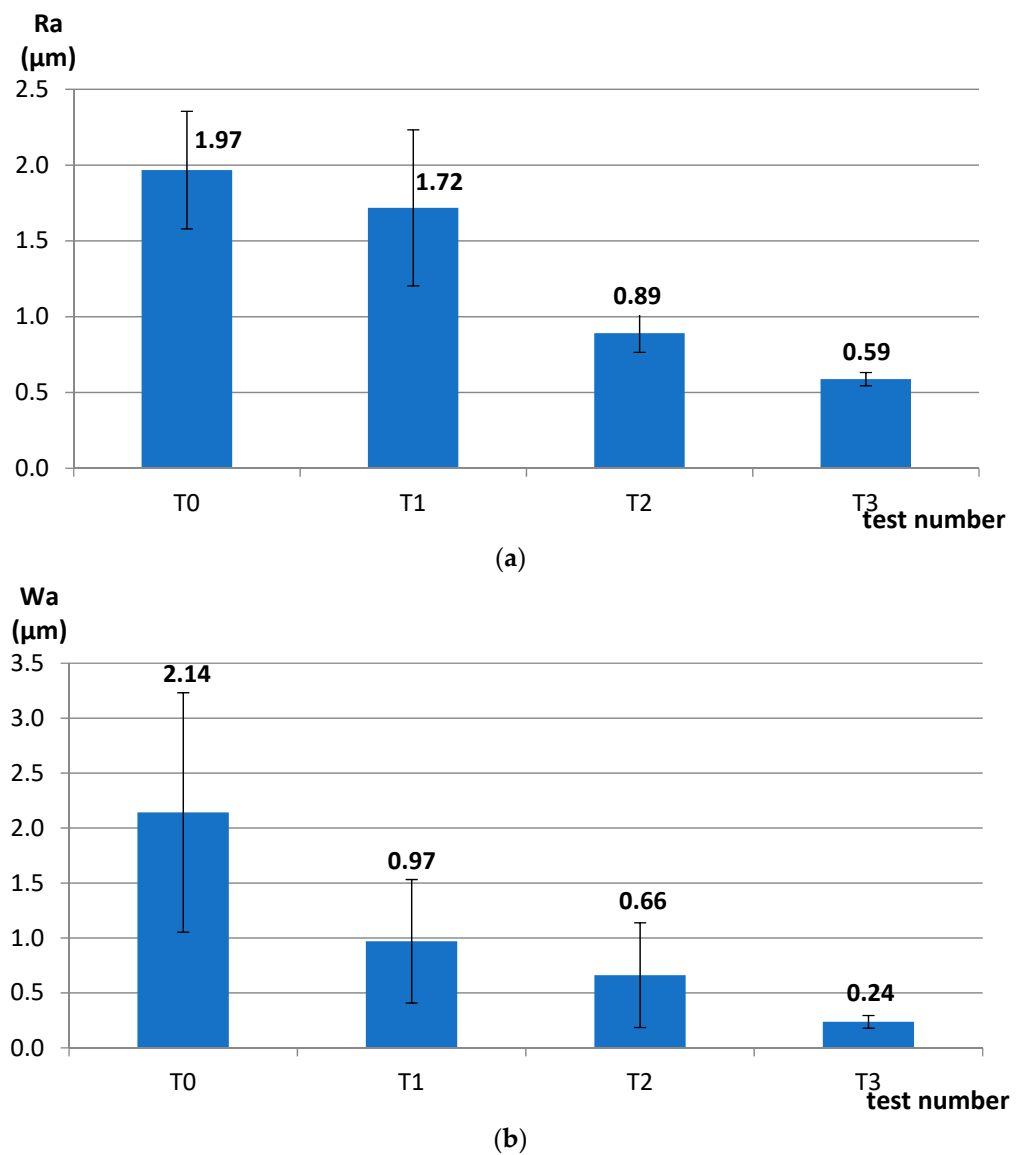
In the first test T1, the use of relatively low process parameters, short machining time, and small diamond grains in the abrasive paste did not result in effective material cutting after 120 s ( $\sim 1 \mu\text{m}$ ), allowing only for a slight decrease in the roughness parameter  $R_a$  and a substantial decrease in the waviness parameter  $W_a$  (Figure 4). The obtained results indicated the need for an increase in the unit pressure  $p$  and kinematical parameters, according to Preston's equation for the material removal rate, which can be written as:

$$\frac{\Delta H}{\Delta t} = k \cdot p \cdot v \quad (1)$$

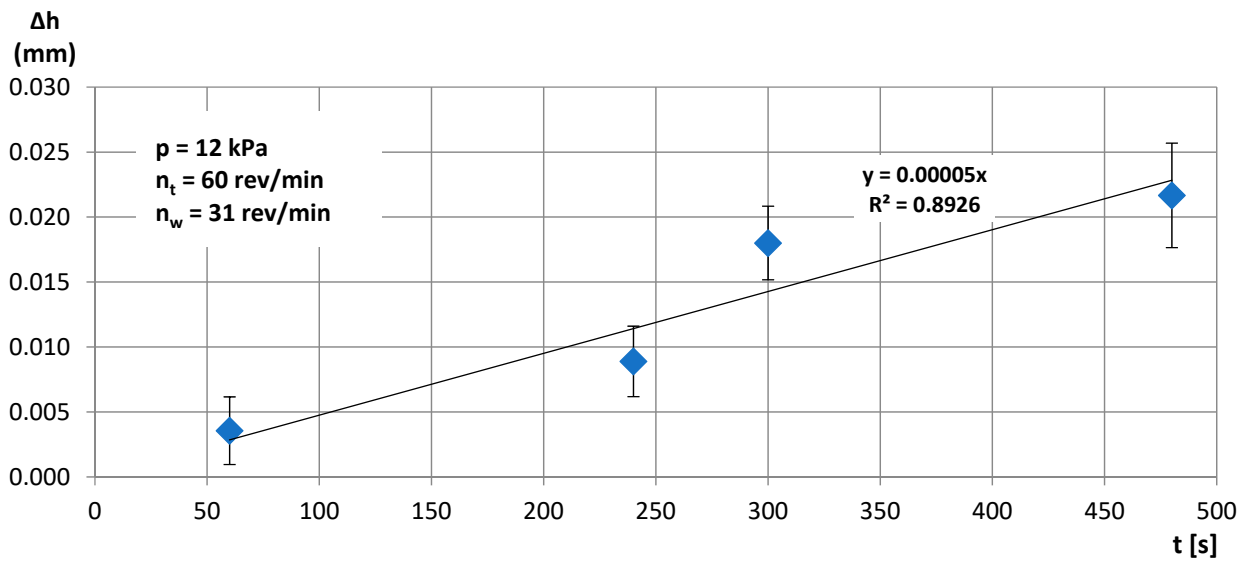
where  $k$  is the Preston constant,  $p$  is the nominal pressure, and  $v$  is the relative velocity. In addition, loose diamond grains D107 were added into the abrasive suspension to intensify the cutting process of hard ceramics in tests T2 and T3.

Increasing the pressure in test T2 to the value of  $p = 12 \text{ kPa}$  allowed for a significant reduction in roughness and waviness parameters (Figure 4) and obtaining a satisfactory material loss (Figure 5a). In the last test T3, the values of the rotational speed of the lapping plate  $n_t$  and the leading ring  $n_w$  were doubled. This resulted in a significant improvement in the surface finish (Figure 4) and in high material removal, directly proportional to the machining time (Figure 5b). The material removal was four-times higher in test T3 after 480 s of machining with a better fitting of the experimental data to the trend lines. Thus, the slope of the equation of the trend line for test T3 was four-times higher than for test T2 with  $R^2 = 0.99$  and  $R^2 = 0.89$  for tests T3 and T2, respectively.

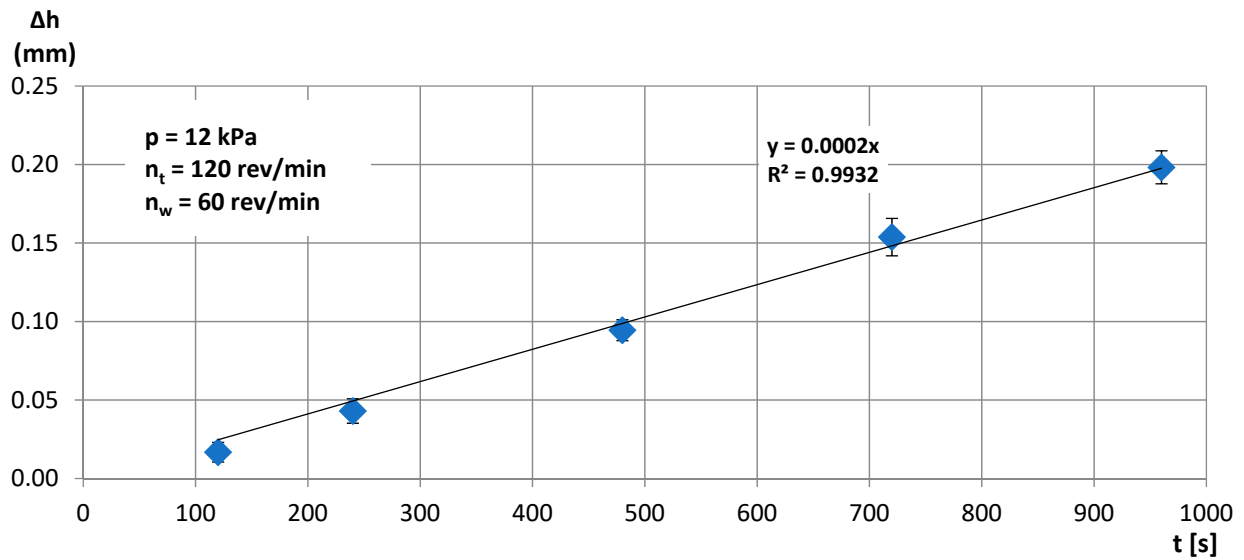
The selected profiles from the 2D measurements of the original and machined surfaces confirmed the significant improvement in the surface finish of the ceramic samples (Figure 6). Diamond grains embedded in the active surface of the soft tool allowed for effective cutting of the hard technical ceramics and improving the surface finish. The embedding of diamonds was confirmed during the microscopic observations of the tool's active surface, as described in the following Section 3.3.



**Figure 4.** Average values of the roughness and waviness parameters after subsequent tests of single-sided lapping of Al<sub>2</sub>O<sub>3</sub> technical ceramics using a prototype tool made by the SLS method (T0—initial state of samples before processing): (a) Ra parameter, (b) Wa parameter; error bars show ± the standard deviation.



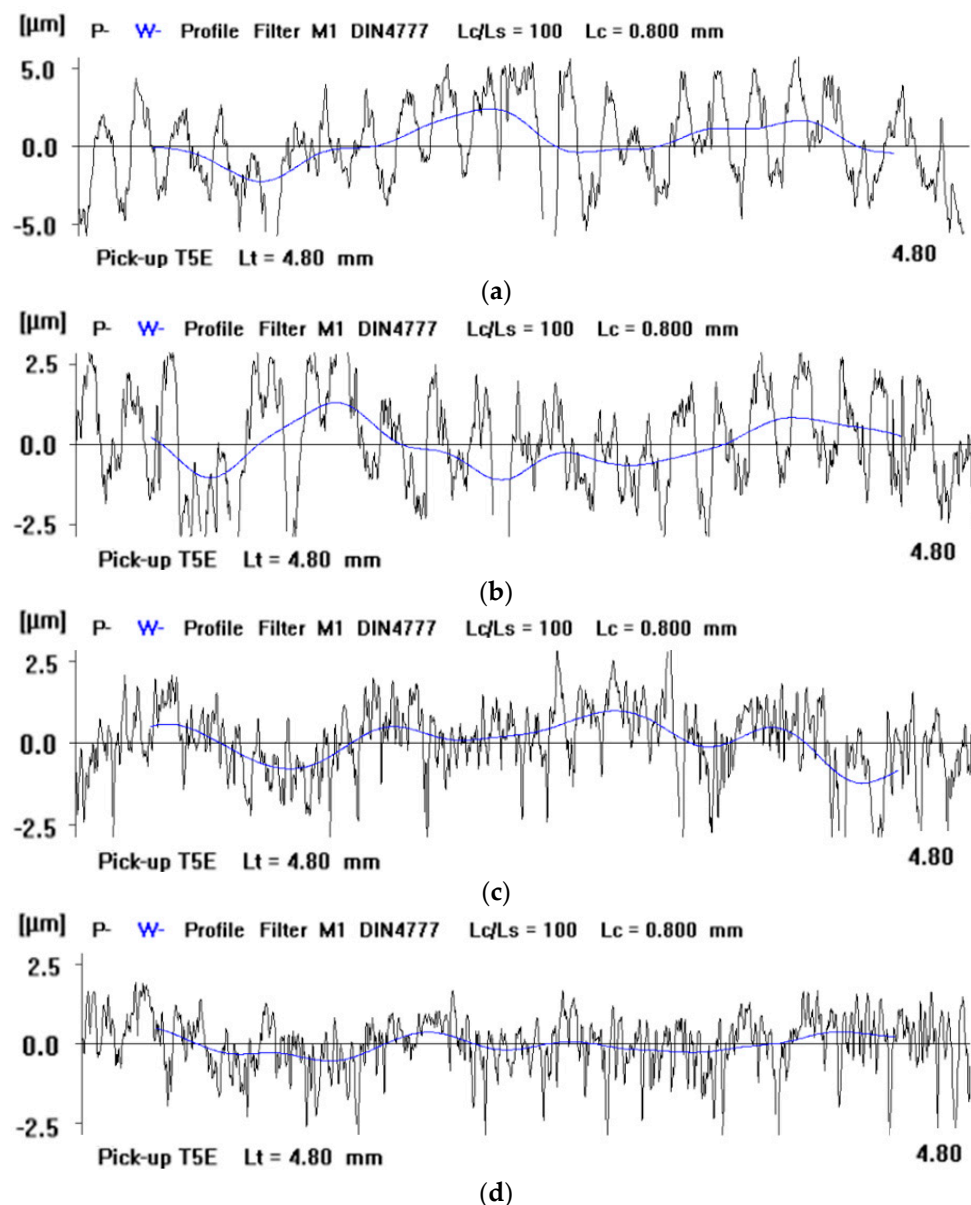
(a)



(b)

**Figure 5.** Cumulative linear material loss obtained in single-sided lapping of  $\text{Al}_2\text{O}_3$  technical ceramics during tests T2 (a) and T3 (b); error bars show  $\pm$  the standard deviation.



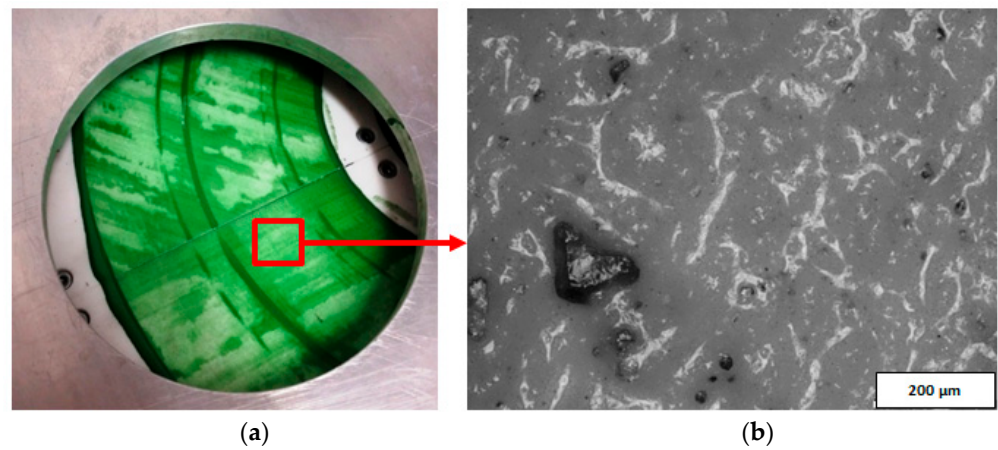


**Figure 6.** Comparison of the profiles measured on the surfaces of the  $\text{Al}_2\text{O}_3$  ceramic samples: (a) initial state before machining, (b) after test T1, (c) after test T2, and (d) after test T3.

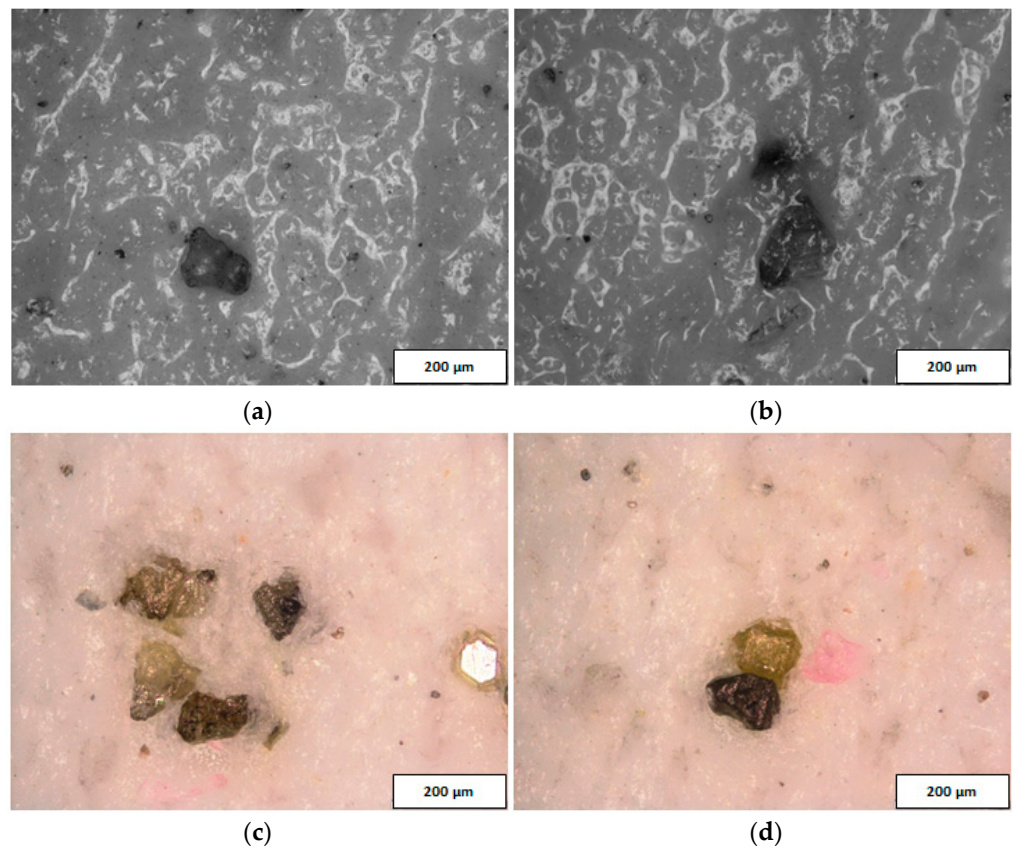
### 3.3. Microscopic Observations of the Tool's Active Surface

The active surface of the prototype abrasive tool was examined using a metallographic microscope OLYMPUS BX51 and dedicated OLYMPUS Stream Motion software. The analysis of the microscopic images confirmed the presence of diamond abrasive grits in the suspension located on the active surface of the tool, even after completing all tests (Figure 7). Diamond grits embedded in the active surface of the tool were also visible after its cleaning from the abrasive suspension. The grits presented in Figure 8 are of different sizes because the abrasive suspension contained mixed abrasive grits with small (D28) and large sizes (D107). Additionally, as a result of the interaction between the workpiece and the lap, the abrasive grits were crushed into smaller pieces. Grits and their fragments were distributed individually on the active surface of the prototype tool (Figure 8a,b), as well as in the form of characteristic conglomerates (Figure 8c,d).



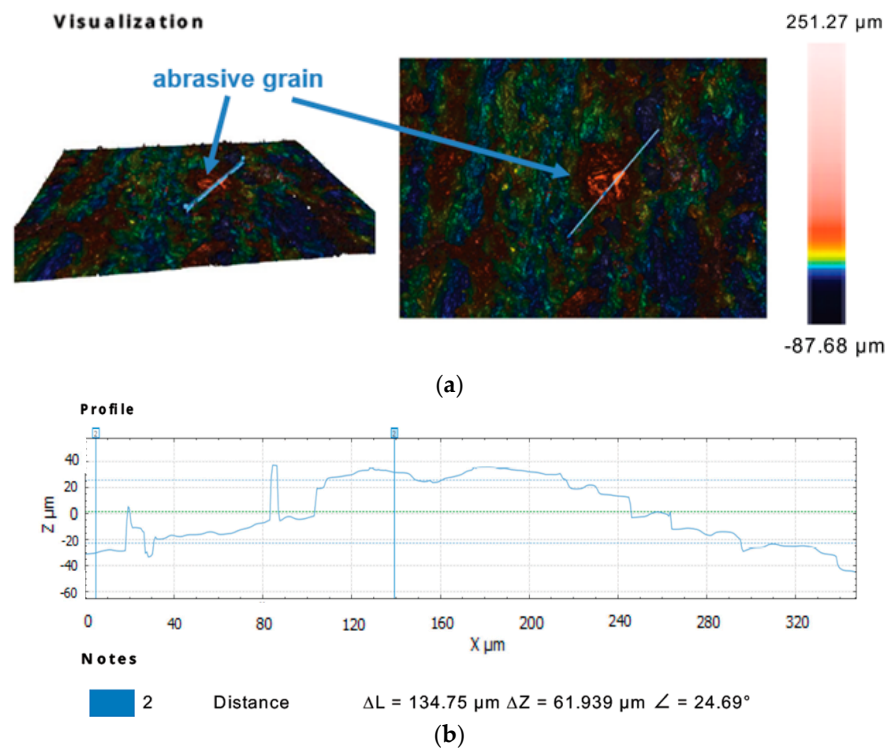


**Figure 7.** The active surface of the prototype tool with an abrasive suspension (a) containing diamond abrasive grits (b) after test T3.

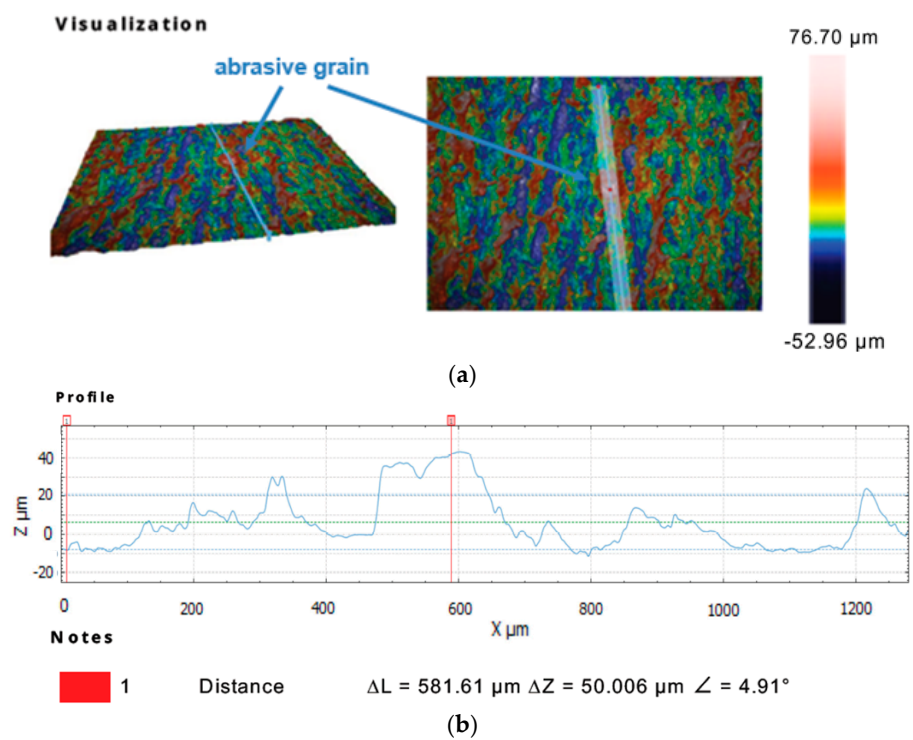


**Figure 8.** Selected sections of the tool's active surface before (a,b) and after (c,d) cleaning from the abrasive suspension.

Further observations of the selected sections of the tool's active surface with the use of the Sneox 3D optical profiler confirmed the exposure of diamond grits above the tool surface (Figures 9 and 10).



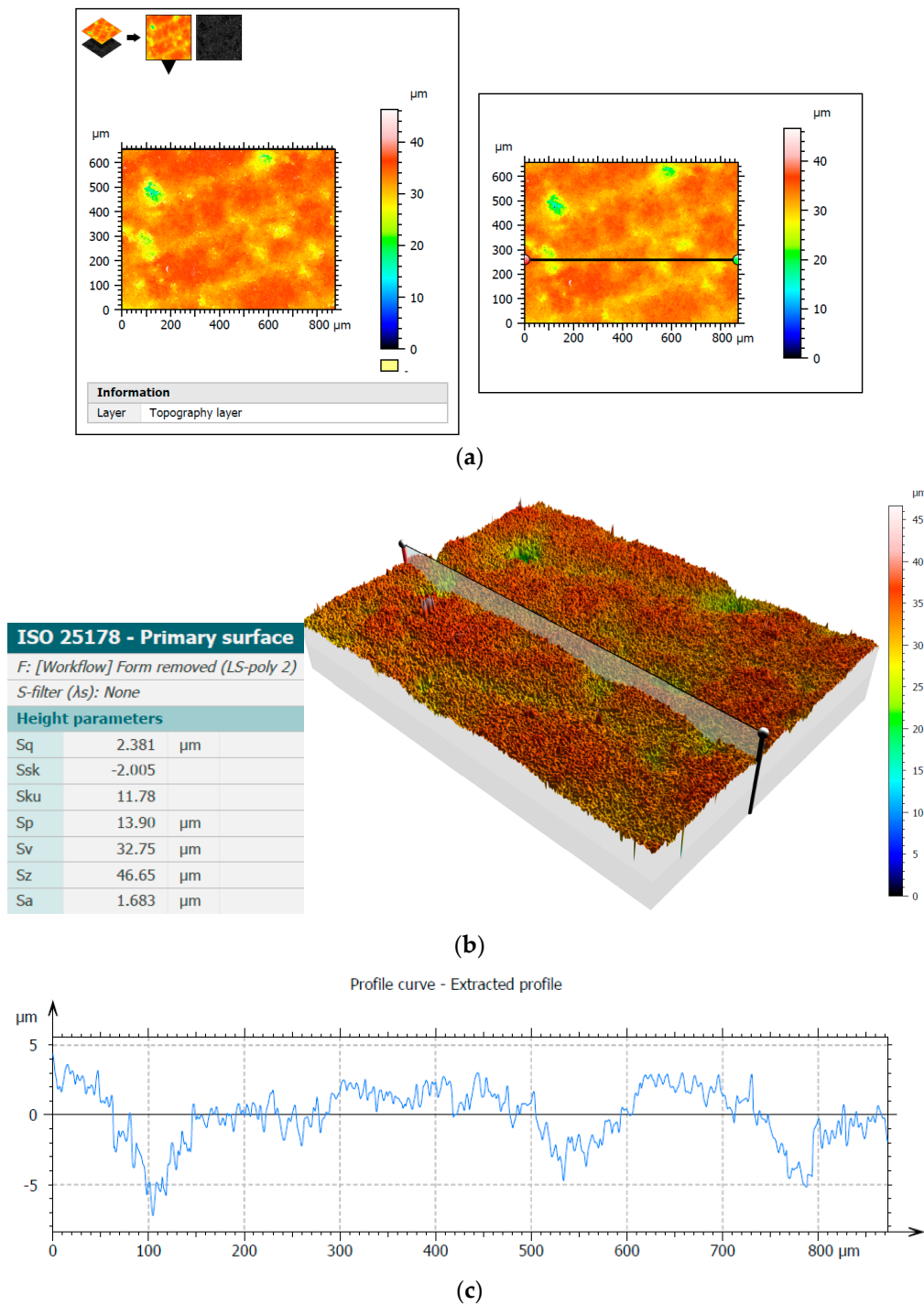
**Figure 9.** Profile extraction for a cross-section containing a diamond abrasive grain using confocal microscopy: a measurement area with the indicated place of an extracted profile (a) and the extracted profile (b).



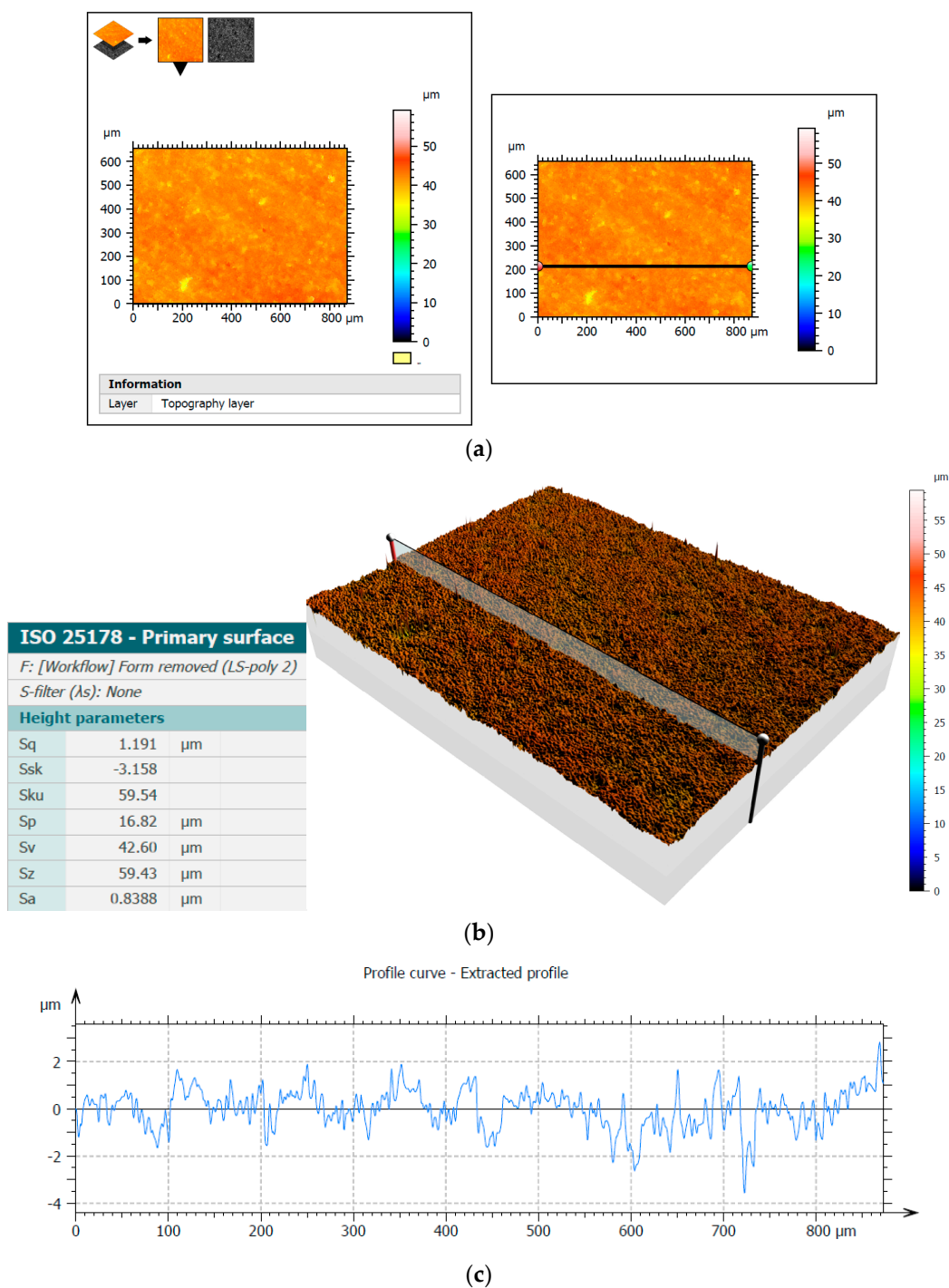
**Figure 10.** Profile extraction for a cross-section containing a diamond abrasive grain using interferometric microscopy: a measurement area with the indicated place of an extracted profile (a) and the extracted profile (b).

### 3.4. Microscopic Observations of the Machined Surfaces of Al<sub>2</sub>O<sub>3</sub> Technical Ceramics

The Sneox 3D optical profiler was used to examine the surface of Al<sub>2</sub>O<sub>3</sub> samples. Figures 11 and 12 show the surface topography before and after machining along with the extracted profiles with the selected height parameters. The primary surface was measured according to the ISO 25178 standards and roughness according to the ISO 4287 standards.



**Figure 11.** Three-dimensional measurement of the surface topography of the Al<sub>2</sub>O<sub>3</sub> sample before experimental tests using confocal microscopy: measurement area with the indicated place of extracted profiles (a), surface topography with selected height parameters (b), and the extracted profile (c).



**Figure 12.** Three-dimensional measurement of surface topography of the  $Al_2O_3$  sample after experimental tests using confocal microscopy: measurement area with the indicated place of extracted profiles (a), surface topography with selected height parameters (b), and the extracted profile (c).

The analysis of the microscopic images and profiles demonstrated a clear improvement in the surface quality, which was also confirmed by a noticeable decrease in the presented height parameters, e.g., the arithmetical mean height  $S_a$  decreased after test T3 from the initial value of  $1.68 \mu m$  to the value of  $0.84 \mu m$ . Moreover, the reduction in the  $S_q$  parameter value from  $2.38 \mu m$  to  $1.19 \mu m$  demonstrated surface smoothing, clearly visible on the three-dimensional surface topography (Figures 11b and 12b). The values of the  $R_a$  parameter determined from the profiles presented in Figures 11c and 12c were  $1.59 \mu m$



and 0.60  $\mu\text{m}$ , respectively, confirming a significant improvement in the surface finish and showing similar values to those obtained from the 2D measurements (Figures 4 and 6).

#### 4. Discussion

The analysis of the results obtained in the particular tests of the experimental study allowed the selection of the process parameters and the type of abrasive suspension for the effective performance of abrasive machining. The use of only SD 28/20 abrasive paste with D28 diamond grains allowed reducing the roughness and waviness of the machined surfaces, but with a very low material removal rate. Adding loose diamond grains of a bigger size D107 to the abrasive slurry resulted in a significantly higher removal of the ceramic material. Thus, the results of the experimental study confirmed that the use of larger abrasive grains enables effective machining of hard technical ceramics, while smaller grains can only be used to improve the surface quality of the machined parts for the applied tool made by the SLS method. The analysis of the spatial images and profiles obtained by confocal and interferometry techniques indicated the places where diamond abrasive grains were embedded. The applied values of the process parameters resulted in the embedding of diamond grains into the active surface of the tool, which was confirmed by microscopic observations (Figures 7 and 8). The implementation of the profile extraction operation for the indicated cross-sections allowed for the estimation of the exposure of the selected grains, which was at the level of about 50  $\mu\text{m}$  (Figures 9 and 10). Thus, the soft material of the prototype tool and its porous structure resulting from the sintering of polyamide powder enabled the easy penetration of the diamond grains into the top layer of the tool's active surface. Consequently, the relatively stable and permanent equipment of the prototype tool with diamond abrasive grains resulted in effective material removal (Figure 5) and a noticeable reduction in the surface roughness and waviness parameters of the  $\text{Al}_2\text{O}_3$  ceramic samples (Figures 4 and 6). This may suggest the transformation of the abrasion mechanism from a two-body abrasion characteristic for conventional lapping to a more effective three-body abrasion characteristic for grinding or lap-grinding.

#### 5. Conclusions

The authors used the selective laser sintering (SLS) method for the production of prototype constructions of abrasive tools applied in flat-lapping technology. The optimistic results of the first experimental tests confirmed the great potential of using this type of tool in lapping technology and the advisability of conducting further research. The use of a prototype SLS-printed tool, with the change of particular input variables, made it possible to remove the material effectively from the  $\text{Al}_2\text{O}_3$  samples and to improve their surface quality significantly. The obtained machining effects allowed the formulation of the following conclusions:

- The use of low kinematic parameters, unit pressure, as well as a short machining time and small abrasive grains did not allow for effective material removal and significant improvement in the surface quality of the samples made of  $\text{Al}_2\text{O}_3$  technical ceramics, except for their waviness;
- An increase in the kinematic parameters, unit pressure, and machining time, as well as adding free large D107 abrasive grains significantly improved the amount of removed material, as well as the surface roughness and waviness parameters measured on the machined surfaces of the  $\text{Al}_2\text{O}_3$  samples;
- A soft and resilient polyamide PA 2200 with flexural modulus 1500 MPa [28] induced the easy embedding of hard diamond grains. Microscopic observations conducted after the experimental tests confirmed the equipment of the tool's active surface with diamond grains. Their permanent embedding in the lapping tool allowed for effective material removal along with the reduction in surface roughness and waviness. Microscopic observations and the obtained technological effects suggested the process transition from conventional lapping treated as three-body abrasion to grinding or lap-grinding treated as two-body abrasion;

- After all tests, no visible signs of damage or excessive wear of the prototype lapping plate were observed. After cleaning the remains of the applied abrasive suspension, the SLS-printed tool was effectively used in the next experimental tests.

In future research, the flat surface of the tool will be analyzed in detail, along with a discussion of the cutting mechanism characteristic for processing ceramics with the use of a lapping disc fabricated by SLS technology. Experiments will be carried out to determine the optimal process parameters and to design a tool with a structure allowing for better technological effects.

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## References

1. Deja, M. Wear of Electroplated Tools Used for Flat Grinding of Ceramics. In *Solid State Phenomena*; Trans Tech Publications Ltd.: Freienbach, Switzerland, 2013; Volume 199, pp. 633–638.
2. Barylski, A.; Deja, M. Finishing of ceramics in a single-disk lapping machine configuration. In *Solid State Phenomena*; Trans Tech Publications Ltd.: Freienbach, Switzerland, 2010; Volume 165, pp. 237–243.
3. Deja, M.; List, M.; Lichtschlag, L.D.; Uhlmann, E. Thermal and technological aspects of double face grinding of Al<sub>2</sub>O<sub>3</sub> ceramic materials. *Ceram. Int.* **2019**, *45*, 19489–19495. [[CrossRef](#)]
4. Deja, M.; Lichtschlag, L.; Uhlmann, E. Thermal and technological aspects of double face grinding of C45 carbon steel. *J. Manuf. Process.* **2021**, *64*, 1036–1046. [[CrossRef](#)]
5. Barylski, A.; Deja, M. Influence of Flat Lapping Kinematics on Machinability of Ceramics. In *Solid State Phenomena*; Trans Tech Publications Ltd.: Freienbach, Switzerland, 2013; Volume 199, pp. 615–620. [[CrossRef](#)]
6. Deja, M. Correlation between shape errors in flat grinding. *J. Vibroengineering* **2012**, *14*, 520–527.
7. Deja, M.; Zieliński, D. Wear of electroplated diamond tools in lap-grinding of Al<sub>2</sub>O<sub>3</sub> ceramic materials. *Wear* **2020**, *460–461*, 203461. [[CrossRef](#)]
8. Barylski, A.; Deja, M. Microgrinding of flat surfaces on single-disc lapping machine. *Int. J. Mach. Mach. Mater.* **2009**, *5*, 245. [[CrossRef](#)]
9. Park, C.; Kim, H.; Lee, S.; Jeong, H. The influence of abrasive size on high-pressure chemical mechanical polishing of sapphire wafer. *Int. J. Precis. Eng. Manuf. Technol.* **2015**, *2*, 157–162. [[CrossRef](#)]
10. Kim, U.S.; Park, J.W. High-Quality Surface Finishing of Industrial Three-Dimensional Metal Additive Manufacturing Using Electrochemical Polishing. *Int. J. Precis. Eng. Manuf. Technol.* **2019**, *6*, 11–21. [[CrossRef](#)]
11. Tan, K.; Yeo, S. Surface finishing on IN625 additively manufactured surfaces by combined ultrasonic cavitation and abrasion. *Addit. Manuf.* **2020**, *31*, 100938. [[CrossRef](#)]
12. Liang, Y.; Dutta, S.P. Application trend in advanced ceramic technologies. *Technovation* **2001**, *21*, 61–65. [[CrossRef](#)]
13. Molaiekiya, F.; Aramesh, M.; Veldhuis, S. Chip formation and tribological behavior in high-speed milling of IN718 with ceramic tools. *Wear* **2020**, *446–447*, 203191. [[CrossRef](#)]
14. Chang, C.-W.; Kuo, C.-P. Evaluation of surface roughness in laser-assisted machining of aluminum oxide ceramics with Taguchi method. *Int. J. Mach. Tools Manuf.* **2007**, *47*, 141–147. [[CrossRef](#)]
15. Lee, T.; Jeong, H.; Kim, H.; Lee, S.; Kim, D. Effect of platen shape on evolution of total thickness variation in single-sided lapping of sapphire wafer. *Int. J. Precis. Eng. Manuf. Technol.* **2016**, *3*, 225–229. [[CrossRef](#)]
16. Pawar, P.; Ballav, R.; Kumar, A. An Overview of Machining Process of Alumina and Alumina Ceramic Composites. *Manuf. Sci. Technol.* **2015**, *3*, 10–15. [[CrossRef](#)]
17. Deja, M.; Zieliński, D.; Kadir, A.; Humaira, S. Applications of Additively Manufactured Tools in Abrasive Machining—A Literature Review. *Materials* **2021**, *14*, 1318. [[CrossRef](#)]

18. Deja, M.; Zielinski, D. A pilot study to assess an in-process inspection method for small diameter holes produced by direct metal laser sintering. *Rapid Prototyp. J.* **2019**, *26*, 418–436. [[CrossRef](#)]
19. Deja, M.; Dobrzyński, M.; Flaszynski, P.; Haras, J.; Zieliński, D. Application of Rapid Prototyping Technology in the Manufacturing of Turbine Blade with Small Diameter Holes. *Pol. Marit. Res.* **2018**, *25*, 119–123. [[CrossRef](#)]
20. Deja, M.; Siemiątkowski, M.S.; Zieliński, D. Multi-Criteria Comparative Analysis of the Use of Subtractive and Additive Technologies in the Manufacturing of Offshore Machinery Components. *Pol. Marit. Res.* **2020**, *27*, 71–81. [[CrossRef](#)]
21. Tian, C.; Li, X.; Zhang, S.; Guo, G.; Wang, L.; Rong, Y. Study on design and performance of metal-bonded diamond grinding wheels fabricated by selective laser melting (SLM). *Mater. Des.* **2018**, *156*, 52–61. [[CrossRef](#)]
22. Tian, C.; Li, X.; Zhang, S.; Guo, G.; Ziegler, S.; Schleifenbaum, J.H.; Wang, L.; Rong, Y. Porous structure design and fabrication of metal-bonded diamond grinding wheel based on selective laser melting (SLM). *Int. J. Adv. Manuf. Technol.* **2018**, *100*, 1451–1462. [[CrossRef](#)]
23. Tian, C.; Li, X.; Li, H.; Guo, G.; Wang, L.; Rong, Y. The effect of porosity on the mechanical property of metal-bonded diamond grinding wheel fabricated by selective laser melting (SLM). *Mater. Sci. Eng. A* **2019**, *743*, 697–706. [[CrossRef](#)]
24. Tian, C.; Li, X.; Li, H.; Guo, G.; Wang, L.; Rong, Y. Study on process and manufacturability of metal-bonded diamond grinding wheel fabricated by selective laser melting (SLM). *J. Phys. Conf. Ser.* **2019**, *1303*, 012144. [[CrossRef](#)]
25. Guo, L.; Zhang, X.; Chen, S.; Hui, J. An Experimental Study on the Precision Abrasive Machining Process of Hard and Brittle Materials with Ultraviolet-Resin Bond Diamond Abrasive Tools. *Materials* **2019**, *12*, 125. [[CrossRef](#)] [[PubMed](#)]
26. Guo, L.; Zhang, X.; Lee, C.-H.; Marinescu, I.D.; Zhang, Y.; Hui, J. An Experimental Study on the Abrasive Machining Process of Electronic Substrate Material with A Novel Ultraviolet-Curable Resin Bond Diamond Lapping Plate. *IEEE Access* **2019**, *7*, 64375–64385. [[CrossRef](#)]
27. Du, Z.-J.; Zhang, F.-L.; Xu, Q.-S.; Huang, Y.-J.; Li, M.-C.; Huang, H.-P.; Wang, C.-Y.; Zhou, Y.-M.; Tang, H.-Q. Selective laser sintering and grinding performance of resin bond diamond grinding wheels with arrayed internal cooling holes. *Ceram. Int.* **2019**, *45*, 20873–20881. [[CrossRef](#)]
28. EOS GmbH. PA 200 Balance 1.0. 2010. Available online: <https://drukarki3d.pl/wp-content/uploads/2015/09/karta-materialowa-PA-2200-ENG.pdf> (accessed on 20 March 2019).